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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

## PCI Express Gen II Compliant, 8-Differential Channel Switch with 8:4 Mux/DeMux Option

## Features

- 8 Differential Channel SPST switch with Mux/DeMux option
- PCI Express Gen II performance
- Low Bit-to-Bit Skew: 10ps (between $+/$ - signals)
- Low Crosstalk: -15dB @ 3.0 GHz
- Low Off Isolation: -26db @ 3.0 GHz
- $\mathrm{V}_{\mathrm{DD}}$ Operating Range: +1.4 V to $+1.8 \mathrm{~V} \pm 10 \%$
- ESD Tolerance $>2 \mathrm{kV}$ HBM
- Packaging (Pb-free \& Green): 42-contact TQFN (ZH42)


## Truth Table

| Function | SEL |
| :---: | :---: |
| $\mathrm{Ax}=\mathrm{Bx}$ |  |
| $\mathrm{Cx}=\mathrm{Dx}$ |  | L

## Block Diagram



## Description

Pericom semiconductor's PI2PCIE2422 is an 8 to 4 channel differential multiplexer/demultiplexer featuring 8 -channel passthrough. It supports two full PCI Express lanes at 5.0 Gbps Gen II performance.

With the select control input low Port A connects to Port B, and Port C connects to port D for an 8-channel differential pass-though. When the select control input is high Port A connects to Port D, and Port B and Port C are in a high-impedance state. The mux/demux function is between Port A and Ports B or D as determined by the select input control.

## Pin Diagram



## Pin Description

| Pin \# | Pin Name | I/O | Description |
| :---: | :---: | :---: | :--- |
| 1,2 | $\mathrm{~A} 0, \mathrm{~A} 1$ | $\mathrm{I} / \mathrm{O}$ | Signal I/O (typically a differential pair) |
| 3,4 | $\mathrm{C} 0, \mathrm{C} 1$ | $\mathrm{I} / \mathrm{O}$ | Signal I/O (typically a differential pair) |
| 5,6 | $\mathrm{~A} 2, \mathrm{~A} 3$ | $\mathrm{I} / \mathrm{O}$ | Signal I/O (typically a differential pair) |
| 7,8 | $\mathrm{C} 2, \mathrm{C} 3$ | $\mathrm{I} / \mathrm{O}$ | Signal I/O (typically a differential pair) |
| 10,11 | $\mathrm{~A} 4, \mathrm{~A} 5$ | $\mathrm{I} / \mathrm{O}$ | Signal I/O (typically a differential pair) |
| 12,13 | $\mathrm{C} 4, \mathrm{C} 5$ | I/O | Signal I/O (typically a differential pair) |
| 14,15 | $\mathrm{~A} 6, \mathrm{~A} 7$ | I/O | Signal I/O (typically a differential pair) |
| 16,17 | $\mathrm{C} 6, \mathrm{C} 7$ | I/O | Signal I/O (typically a differential pair) |
| 22,23 | D7, D6 | I/O | Signal I/O (typically a differential pair) |
| 24,25 | B7, B6 | I/O | Signal I/O (typically a differential pair) |
| 26,27 | D5, D4 | I/O | Signal I/O (typically a differential pair) |
| 28,29 | B5, B4 | I/O | Signal I/O (typically a differential pair) |
| 31,32 | D3, D2 | I/O | Signal I/O (typically a differential pair) |
| 33,34 | B3, B2 | I/O | Signal I/O (typically a differential pair) |
| 35,36 | D1, D0 | I/O | Signal I/O (typically a differential pair) |
| 37,38 | B1, B0 | I/O | Signal I/O (typically a differential pair) |
| 9 | SEL | I | Operation mode Select <br> (when SEL=0: A $\rightarrow$ B, C $\rightarrow D, ~ w h e n ~ S E L=1: ~ A ~$$\rightarrow$ D, B \& C=Hi-Z) |

## Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

| Storage Temperature ... | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| :---: | :---: |
| Supply Voltage to Ground Potential. | -0.5 V to +2.5 V |
| DC Input Voltage | -0.5 V to $\mathrm{V}_{\mathrm{DD}}$ |
| DC Output Current. | .. 120mA |
| Power Dissipation | ... 0.5 W |


#### Abstract

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.


## DC Electrical Characteristics for Switching over Operating Range

( $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=1.4 \mathrm{~V}$ to $1.8 \mathrm{~V} \pm 10 \%$ )

| Paramenter | Description | Test Conditions | Min | Typ ${ }^{(1)}$ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VIH | Input HIGH Voltage | Guaranteed HIGH level | $0.65 \times \mathrm{V}_{\mathrm{DD}}$ |  |  | V |
| VIL | Input LOW Voltage | Guaranteed LOW level | -0.5 |  | $\begin{gathered} 0.35 \mathrm{x} \\ \mathrm{~V}_{\mathrm{DD}} \end{gathered}$ |  |
| VIK | Clamp Diode Voltage | $\mathrm{V}_{\mathrm{DD}}=$ Max., $\mathrm{I}_{\mathrm{IN}}=-18 \mathrm{~mA}$ |  | $-0.7$ | -1.2 |  |
| IIH | Input HIGH Current | $\mathrm{V}_{\mathrm{DD}}=$ Max., $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\mathrm{DD}}$ |  |  | $\pm 5$ | $\mu \mathrm{A}$ |
| IIL | Input LOW Current | $\mathrm{V}_{\mathrm{DD}}=\mathrm{Max} ., \mathrm{V}_{\mathrm{IN}}=\mathrm{GND}$ |  |  | $\pm 5$ |  |
| $\mathrm{R}_{\mathrm{ON}}$ | On Resistance | $\mathrm{V}_{\mathrm{DD}}=$ Min., $\mathrm{V}_{\mathrm{IN}}=1.3 \mathrm{~V}, \mathrm{I}_{\mathrm{IN}}=40 \mathrm{~mA}$ |  |  | 10 | Ohm |
| $\mathrm{Con}_{\text {O }}(\mathrm{AB})$ | Capacitance on A/B, C/D | $\mathrm{V}_{\mathrm{IN}}=0, \mathrm{~V}_{\mathrm{DD}}=1.8 \mathrm{~V}$ |  | 2.0 |  | pF |

Note:

1. Typical values are at $\mathrm{V}_{\mathrm{DD}}=1.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ambient and maximum loading.

## Power Supply Characteristics

| Parameters | Description | Test Conditions ${ }^{(\mathbf{1 )}}$ | Min. | Typ. ${ }^{(\mathbf{2})}$ | Max. | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{DD}}$ | Quiescent Power Supply Current | $\mathrm{V}_{\mathrm{DD}}=$ Max., $\mathrm{V}_{\mathrm{IN}}=$ GND or $\mathrm{V}_{\mathrm{DD}}$ |  |  | 400 | $\mu \mathrm{~A}$ |

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
2. Typical values are at $\mathrm{V}_{\mathrm{DD}}=1.8 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ambient and maximum loading.

## Dynamic Electrical Characteristics Over the Operating Range

( $\mathrm{T}_{\mathrm{A}}=-40^{\circ}$ to $+85^{\circ} \mathrm{C}, \mathrm{V} D \mathrm{DD}=1.8 \mathrm{~V} \pm 10 \%, \mathrm{GND}=0 \mathrm{~V}$ )

| Parameter | Description | Test Conditions | Min. | Typ. ${ }^{(1)}$ | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{X}_{\text {TALK }}$ | Crosstalk | $\begin{aligned} \text { See Fig. } 1 \text { for Measurement Setup, } \mathrm{f} & =3.00 \mathrm{GHz} \\ \mathrm{f} & =100 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & -15 \\ & -50 \end{aligned}$ |  | dB |
| OIRR | OFF Isolation | $\begin{aligned} \text { See Fig. } 2 \text { for Measurement Setup, } \mathrm{f} & =3.00 \mathrm{GHz} \\ \mathrm{f} & =100 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & -15 \\ & -45 \end{aligned}$ |  |  |
| ILOSS | Differential Insertion Loss | $\mathrm{f}=3 \mathrm{GHz}$ |  | -3 |  |  |
| BW | Bandwidth (-3dB) |  |  | 2.5 |  | GHz |

Notes:

1. Guaranteed by design. Typical values are at $\mathrm{V}_{\mathrm{DD}}=1.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ ambient and maximum loading.

HP4396B


Fig 1: Crosstalk Setup

HP4396B


Fig 2: Off-isolation setup


Fig 3: Typical Crosstalk Plot from 1 MHz to $6.0 \mathrm{GHz}, \mathrm{VDD}=1.5 \mathrm{~V}, \mathbf{2 5}^{\circ} \mathrm{C}$


Fig 4: Typical Off Isolation Plot from 1 MHz to $6.0 \mathrm{GHz}, \mathrm{V}_{\mathrm{DD}}=\mathbf{1 . 5 V}, \mathrm{TA}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$


Fig 5: Typical Insertion Loss Plot from 1 MHz to $6.0 \mathrm{GHz}, \mathrm{VDD}=1.5 \mathrm{~V}, \mathbf{2 5 C}$

## Switching Characteristics

( $\mathrm{T}_{\mathrm{A}}=-40^{\circ}$ to $+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=1.5 \mathrm{~V} \pm 10 \%$ )

| Paramenter | Description | Min. | Typ. | Max. | Units |
| :--- | :--- | :---: | :---: | :---: | :---: |
| tPZH, tPZL | Line Enable Time - SEL to AN, BN | 0.5 |  | 15 | ns |
| tpHZ, tPLZ | Line Disable Time - SEL to AN, BN | 0.5 |  | 15 |  |
| $\mathrm{t}_{\mathrm{b}-\mathrm{b}}$ | Bit-to-bit skew within same differential pair |  |  | 10 | ps |
| $\mathrm{t}_{\mathrm{ch}}-\mathrm{t}_{\mathrm{ch}}$ | Channel-to-channel timing skew |  |  | 50 |  |

## Test Circuit for Electrical Characteristics ${ }^{(1-5)}$



Notes:

1. $\mathrm{C}_{\mathrm{L}}=$ Load capacitance: includes jig and probe capacitance.
2. $\quad \mathrm{R}_{\mathrm{T}}=$ Termination resistance: should be equal to $\mathrm{Z}_{\text {OUT }}$ of the Pulse Generator
3. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
4. All input impulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{R}} \leq 2.5 \mathrm{~ns}, \mathrm{t}_{\mathrm{F}} \leq 2.5 \mathrm{~ns}$.
5. The outputs are measured one at a time with one transition per measurement.

## Switch Positions

| Test | Switch |
| :---: | :---: |
| tplz, $^{\text {t }}$ PZL (output on B-side) | $2 \times \mathrm{V}_{\text {DD }}$ |
| $\mathrm{t}_{\text {PHZ }}$, $\mathrm{P}_{\text {PZH }}$ (output on B-side) | GND |
| Prop Delay | Open |

## Test Circuit for Dynamic Electrical Characteristics



## Switching Waveforms



Voltage Waveforms Enable and Disable Times

PCI Express Gen II Compliant, 8-Differential Channel Switch with 8:4 Mux/DeMux Option

## Applications Information

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd

PCI Express Application Specific Measurements and Test Set-up


Figure 6: the test set-up for the PI2PCIE2422 eye test

Notes:

1. A modified PI2PCIE2422 application board with 16-inch differential trace is used for Eye management.
2. Agilent N4902B BERT is used to generate a K28.5 pattern at 5 Gbps with 500 mV single-end swing.
3. To create the P12PCIE2422-free test condition, the PI2PCIE2422 chip is removed and a wire is connected between the trace and output probe.
4. An Agilent Infinuum 54855A is used and Serial Data Analysis software is ran to capture the Eye.

## Packaging Mechanical: 42-Contact TQFN (ZH)



Ordering Information

| Ordering Code | Package Code | Package Description |
| :---: | :---: | :---: |
| PI2PCIE2422ZHE | ZH | 42-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN) |

Notes:

1. Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
2. $\mathrm{E}=$ Lead-free and green
3. X suffix $=$ tape and reel
